Docket No.

## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one na					
joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is					
sought on the invention entitled entitled SEMICONDUCTOR	<u>R LASER DIODE HAVING A PCB TYPE</u>				
LEAD FRAME the specification of which					
[ ]is attached hereto					
[]was filed on as Application Serial No	and was amended on				
(if applicable)	-				
I hereby state that I have reviewed and understand the contents of the above identified specification including the claims as amended by any amendment referred to above.					
I acknowledge the duty to disclose information which is known to me to be material to patentability in accordance with Title 37, Code of Federal Regulations, Section 1. 56.					
I hereby claim foreign priority benefits under Title 35, United 3365(b) of any foreign application(s) for patent or inventor's international application which designated at least one country and have also identified below any foreign application for patent before that of the application on which priority is claimed:	certificate, or Section 365(a) of any PCT other than the United States, listed below				
Prior Foreign Application(s):	Priority Claimed				
Number Country Day/Month/Year Filed	Yes No				
<u> </u>	<u></u>				
2003-65017 Korea 19/September/2003	XX				
I hereby claim the benefit under 35 USC §119(e) of any Unibelow.  Prior Provisional Application(s)	ited States provisional application(s) listed				
Application Number Filing Date					

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s), or Section 365(c) of any PCT international application designating the United States, listed below and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, code of Federal Regulations, Section 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Status: Patented.Pending. Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s): Allan M. Lowe, Reg. No. 19.641; Benjamin J. Hauptman, Reg. No. 29,310; Israel Gopstein, Reg. No. 27,333; Kenneth M. Bemer, Reg. No. 37,093; Michael G. Gilman, Reg. No. 19,114; and Randy Noranbrock, Reg. No. 42, 940, all of

with full power of substitution and revocation, to prosecute this application and to transact all business in

LOWE HAUPTMAN GOPSTEIN GILMAN & BERNER, LLP 1700 Diagonal Road, Suite 310 Alexandria, Virginia 22314

to them.	nark Oπice connected therewith, and all future correspondence should be addressed					
*********	**********************					
Full name of sole or first inventor: PARK, Chan Wang						
Inventor's signature:	Park Chan Wang Date: December 2, 2003					
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**************************************						
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nventor's signature:	Jory Ik Park Date: December 2, 2003					
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Citizenship:	Republic of Korea					
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****						

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Full name of third inve	ntor: AHN, Moon Bong				
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******	************	******	***********		
Full name of fourth inv	ventor: YANG, Si Joong				
Inventor's signature:	Sava	Date:	December 2, 2003		
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*******	*************	******	*********		
Full name of fifth inver	ntor: KIM, Dae Ho				
Inventor's signature:	BDH	Date:	December 2, 2003		
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